

N-Channel 100 V (D-S) MOSFET

D q

PRODUCT SUMMARY					
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A)			
100	0.114 at V _{GS} = 10 V	15			

FEATURES

- TrenchFET[®] Power MOSFET
- 175 °C Junction Temperature
- PWM Optimized
- 100 % R_g Tested
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

• Primary Side Switch

	G
L L G D S	N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS ($T_A = 25 \text{ °C}$, unless otherwise noted)							
Parameter	Symbol	Limit	Unit				
Drain-Source Voltage	V _{DS}	100	v				
Gate-Source Voltage		V _{GS}	± 20	V			
Continuous Drain Current (T. 475 °C)b	T _C = 25 °C	1-	15				
Continuous Drain Current (T _J = 175 °C) ^b	T _C = 125 °C		13	1			
Pulsed Drain Current	I _{DM}	40	А				
Continuous Source Current (Diode Conduction)	۱ _S	3					
Avalanche Current	I _{AS}	3					
Single Pulse Avalanche Energy	L = 0.1 mH	E _{AS}	18	mJ			
Maximum Dawar Dissinction	T _C = 25 °C	P.	96 ^b	10/			
Maximum Power Dissipation	T _A = 25 °C	P _D	3 ^a	- W			
Operating Junction and Storage Temperature Range	-	T _J , T _{stg}	- 55 to 175	°C			

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
	t ≤ 10 s	R _{thJA}	15	18			
Junction-to-Ambient ^a	Steady State		40	50	°C/W		
Junction-to-Case (Drain)	·	R _{thJC}	0.85	1.1			

Notes:

a. Surface mounted on 1" x 1" FR4 board.

b. See SOA curve for voltage derating.

Parameter Static

SPECIFICATIONS (T_J = 25 °C, u

Drain-Source Breakdown Voltage

Zero Gate Voltage Drain Current

Drain-Source On-State Resistance^b

Gate Threshold Voltage Gate-Body Leakage

On-State Drain Current^b

Forward Transconductanceb

				\mathbb{B}°	VBse	
				www.V		
, unless c	therwise noted)					
Symbol	Test Conditions	Min.	Typ. ^a	Max.	Unit	
V _{DS}	$V_{GS} = 0 V, I_D = 250 \mu A$	100			v	
V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1.0		2.5		
I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
	$V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V}$			1		
I _{DSS}	$V_{DS} = 100 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 ^{\circ}\text{C}$			50	μA	
	$V_{DS} = 100 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 175 ^{\circ}\text{C}$			250		
I _{D(on)}	$V_{DS} = 5 V, V_{GS} = 10 V$	40			А	
	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 3 \text{ A}$		0.114			
D	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 3 \text{ A}, \text{ T}_{J} = 125 \text{ °C}$		0.120		Ω	
R _{DS(on)}	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 3 \text{ A}, \text{ T}_{J} = 175 \text{ °C}$		0.140			
	$V_{GS} = 4.5 \text{ V} \text{ I}_{D} = 3 \text{ A}$		0.120			
9 _{fs}	V _{DS} = 15 V, I _D = 3 A		35		S	
Cicc			950			

Dynamic ^a						
Input Capacitance	Ciss			950		
Output Capacitance	C _{oss}	V_{GS} = 0 V, V_{DS} = 25 V, F = 1 MHz		120		pF
Reverse Transfer Capacitance	C _{rss}			60		
Total Gate Charge ^c	Qg			24	41	
Gate-Source Charge ^c	Q _{gs}	$V_{DS} = 50 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 3 \text{ A}$		8		nC
Gate-Drain Charge ^c	Q _{gd}			12		
Gate Resistance	R _g		0.5		2.9	Ω
Turn-On Delay Time ^c	t _{d(on)}			15	25	
Rise Time ^c	t _r	$V_{DD} = 50 \text{ V}, \text{ R}_{L} = 5.2 \Omega$		50	75	
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong 3 \text{ A}, \text{ V}_{\text{GEN}} = 10 \text{ V}, \text{ R}_g = 2.5 \Omega$		30	45	ns
Fall Time ^c	t _f			60	90	
Source-Drain Diode Ratings and Char	acteristics (1	Γ _C = 25 °C)				
Pulsed Current	I _{SM}				5	A
Diode Forward Voltage ^b	V _{SD}	I _F = 3 A, V _{GS} = 0 V		0.9	1.5	V
Source-Drain Reverse Recovery Time	t _{rr}	I _F = 3 A, dl/dt = 100 A/μs		180	250	ns

Notes:

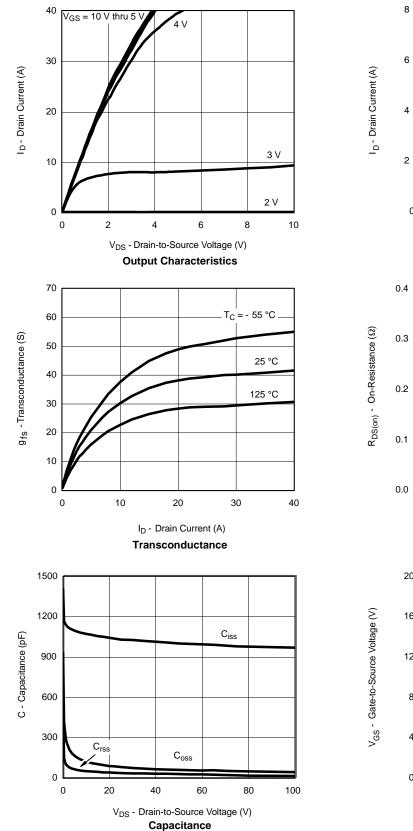
a. Guaranteed by design, not subject to production testing.

b. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

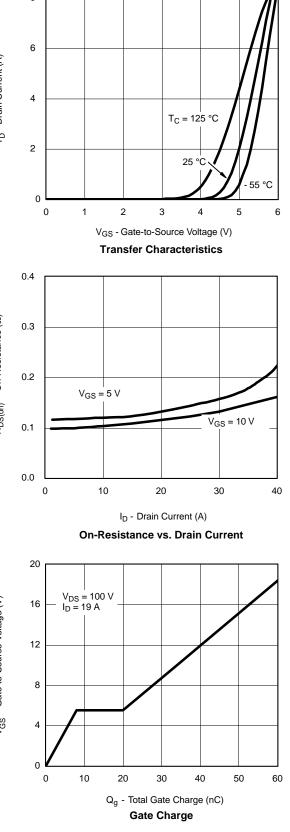
c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.





TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



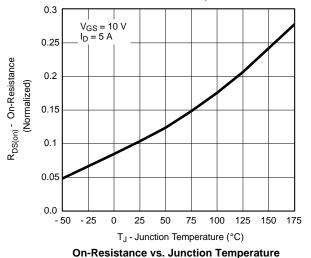


T_J = 25 °C

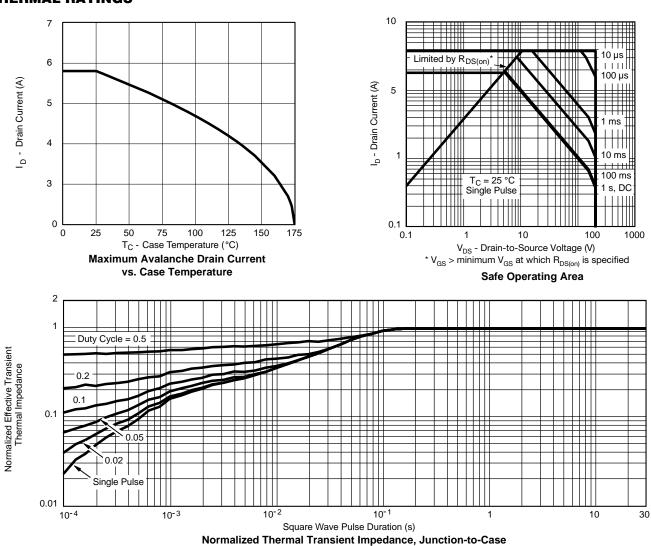
0.9

1.2









100

10

1

0

0.3

T_J = 150 °C

0.6

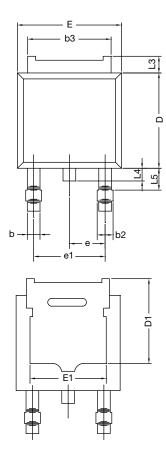
Source-Drain Diode Forward Voltage

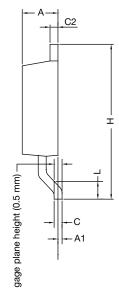
V_{SD} - Source-to-Drain Voltage (V)

I_S - Source Current (A)



TO-252AA CASE OUTLINE





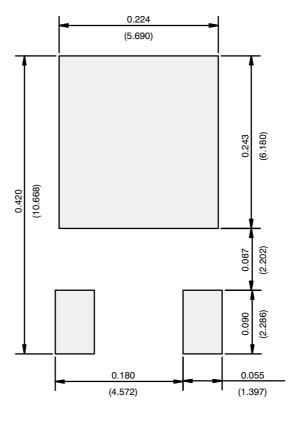
	MILLIN	METERS	INC	HES		
DIM.	MIN.	MAX.	MIN.	MAX.		
А	2.18	2.38	0.086	0.094		
A1	-	0.127	-	0.005		
b	0.64	0.88	0.025	0.035		
b2	0.76	1.14	0.030	0.045		
b3	4.95	5.46	0.195	0.215		
С	0.46	0.61	0.018	0.024		
C2	0.46	0.89	0.018	0.035		
D	5.97	6.22	0.235	0.245		
D1	5.21	-	0.205	-		
E	6.35	6.73	0.250	0.265		
E1	4.32	-	0.170	-		
Н	9.40	10.41	0.370	0.410		
е	2.28	BSC	0.090 BSC			
e1	4.56	4.56 BSC		BSC		
L	1.40	1.78	0.055	0.070		
L3	0.89	1.27	0.035	0.050		
L4	-	1.02	-	0.040		
L5	1.14	1.52	0.045	0.060		
ECN: X12-0247-Rev. M, 24-Dec-12 DWG: 5347						

Note

• Dimension L3 is for reference only.



RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)



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